3RD GENERATION PARTNERSHIP PROJECT 2 "3GPP2"

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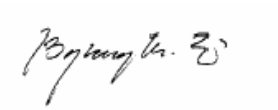
Ms. Betsy Covell
Chair, 3GPP2 TSG-X
Lucent Technologies
tsgx_chair@3gpp2.org

Re: OMA Liaison

Dear Betsy;

3GPP2 TSG-C has examined the attachment [X00-20050314-043 OMA MWG re Inclusion-of-3GPP-PSS6-SMIL] and agrees with the content included for the MM content classes for 3GPP2. 3GPP2 TSG-C also wishes to inform OMA MWG that it has reached consensus on the next version of 3GPP2 SMIL to be included in C.S0050 Release A. The 3GPP2 SMIL REL A profile is a superset of 3GPP SMIL REL6. In addition to 3GPP SMIL REL 6 capability, four additional optional SMIL modules are available. The detailed differences are contained in the attachment, which will be included as an informative annex of C.S0050-A. Incorporation of this information in the OMA specification would be useful in achieving interoperability.

Regards,



Byung K. (BK) Yi
Chair, 3GPP2 TSG-C

cc:	Y.K. Kim	3GPP2 SC Chair	ykkim@lgtel.kr.co
	Henry Cuschieri	3GPP2 Secretariat	hcuschieri@tiaonline.org

Attachment

Att: Annex C SMIL Profile Differences between 3GPP2 and 3GPP (Informative)